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Quad Buffer/Line Driver with 3-State Output



ADE-205-366 (Z) 1st. Edition Sep. 2000

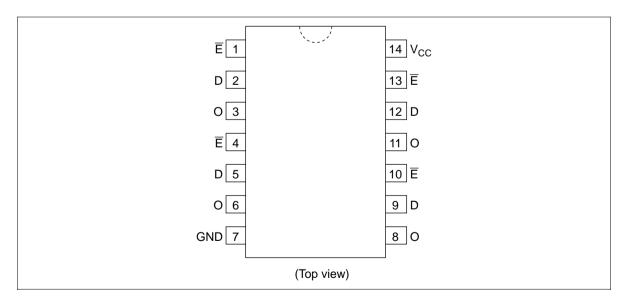
#### Description

The HD74AC125/HD74ACT125 is an quad buffer and line driver designed to be employed as a memory address driver, clock driver and bus oriented transmitter/receiver which provides improved PC board density.

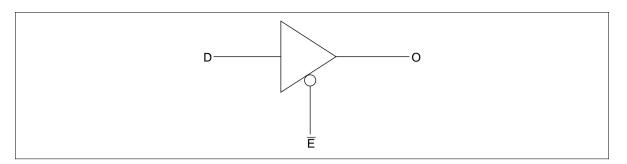
#### Features

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Outputs Source/Sink 24 mA
- HD74ACT125 has TTL-Compatible Inputs

#### **Pin Arrangement**



#### Logic Symbol



#### **Pin Names**

- D Data Inputs
- E3-State Output Enable Inputs (Active Low)
- O Outputs

#### **Truth Table**

#### Inputs

Ē	D	Output
L	L	L
L	Н	Н
Н	Х	Z

H : High Voltage Level

L : Low Voltage Level

X : Immaterial

Z : High Impedance

#### DC Characteristics (unless otherwise specified)

Item	Symbol	Max	Unit	Condition
Maximum quiescent supply current	I <sub>cc</sub>	80	μΑ	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 V$ , Ta = Worst case
Maximum quiescent supply current	I <sub>cc</sub>	8.0	μA	$V_{IN} = V_{CC}$ or ground, $V_{CC} = 5.5 \text{ V}$ , Ta = 25°C
Maximum I <sub>cc</sub> /input (HD74ACT125)	I <sub>cct</sub>	1.5	mA	$V_{IN} = V_{CC} - 2.1 \text{ V}, V_{CC} = 5.5 \text{ V}$ Ta = Worst case



#### AC Characteristics: HD74AC125

			Ta = + C <sub>∟</sub> = 50			Ta = −40°C to +85°C C <sub>L</sub> = 50 pF		
ltem	Symbol	V <sub>cc</sub> (V)* <sup>1</sup>	Min	Тур	Мах	Min	Max	Unit
Propagation delay	t <sub>PLH</sub>	3.3	1.0	6.5	9.0	1.0	10.0	ns
		5.0	1.0	5.5	7.0	1.0	7.5	
Propagation delay	t <sub>PHL</sub>	3.3	1.0	6.5	9.0	1.0	10.0	
		5.0	1.0	5.0	7.0	1.0	7.5	
Enable time	t <sub>zH</sub>	3.3	1.0	6.0	10.5	1.0	11.0	
		5.0	1.0	5.0	7.0	1.0	8.0	
Enable time	t <sub>zL</sub>	3.3	1.0	7.5	10.0	1.0	11.0	
		5.0	1.0	5.5	8.0	1.0	8.5	
Disable time	t <sub>HZ</sub>	3.3	1.0	7.0	10.0	1.0	10.5	
		5.0	1.0	6.5	9.0	1.0	9.5	
Disable time	t <sub>LZ</sub>	3.3	1.0	7.5	10.5	1.0	11.5	
		5.0	1.0	6.5	9.0	1.0	9.5	_

Note: 1. Voltage Range 3.3 is  $3.3 V \pm 0.3 V$ 

Voltage Range 5.0 is 5.0 V  $\pm$  0.5 V

#### AC Characteristics: HD74ACT125

		Ta = +25°C C <sub>∟</sub> = 50 pF			Ta = –4 C <sub>∟</sub> = 50			
Item	Symbol	V <sub>cc</sub> (V)* <sup>1</sup>	Min	Тур	Мах	Min	Max	Unit
Propagation delay	t <sub>PLH</sub>	5.0	1.0	6.5	9.0	1.0	10.0	ns
Propagation delay	t <sub>PHL</sub>	5.0	1.0	7.0	9.0	1.0	10.0	
Enable time	t <sub>zH</sub>	5.0	1.0	6.0	8.5	1.0	9.5	
Enable time	t <sub>zL</sub>	5.0	1.0	7.0	9.5	1.0	10.5	
Disable time	t <sub>HZ</sub>	5.0	1.0	7.0	9.5	1.0	10.5	
Disable time	t <sub>LZ</sub>	5.0	1.0	7.5	10.0	1.0	10.5	_

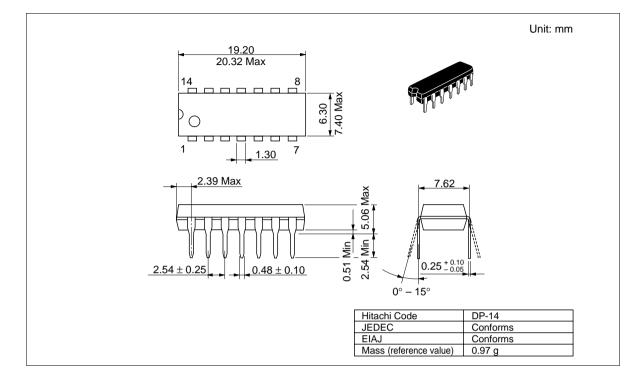
Note: 1. Voltage Range 5.0 is 5.0 V  $\pm$  0.5 V

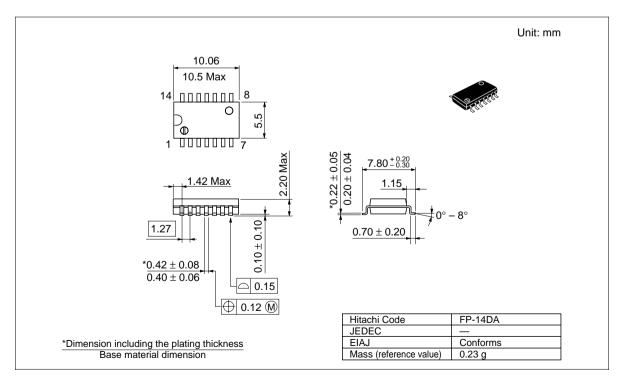
#### Capacitance

ltem	Symbol	Тур	Unit	Condition
Input capacitance	C <sub>IN</sub>	4.5	pF	$V_{cc} = 5.5 V$
Power dissipation capacitance	$C_{PD}$	45.0	pF	$V_{cc} = 5.0 V$

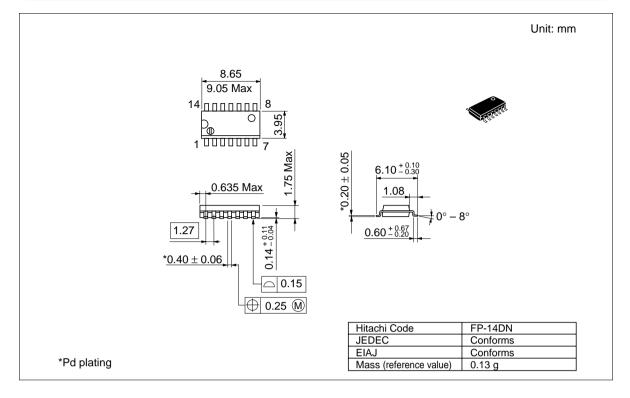
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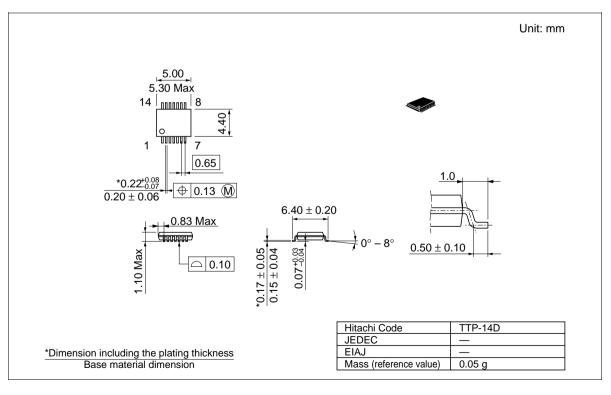
#### **Package Dimensions**











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